Year 4 Review Dresden, March 16th, 2012

Cluster

### Achievements and Perspectives :

# Hardware Platforms and MPSoC Design

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## **Overall High-Level Objectives and Vision**

- Focus on Design and Analysis
- Hardware architecture and software components in their interaction
- Tools for accurate estimation
- Growing importance of resource awareness in embedded systems
- Design methodology
  - Scales to massively parallel and heterogeneous multiprocessor architectures
  - Allows for predictable system properties
  - Uses the available hardware resources in an efficient manner
- Adaptivity

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- Robustness
- Life-time management
- Resilience



## **Integration Achieved**

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in the area, in Europe GA - Pilot GA - FET Flagship ARTEMIS SRA Multitherman - ERC **STRATEGIC** NANOSYS - ERC **ARTEMIS T-CREST** FP7 **GENESI** EURETILE PROD3D iFest **ASAM SMECY** RECOMP SYSMODEL **GRAFTERS** CERTAINTY **SCALOPES** COMBEST **PREDATOS** IoE GALAXY ARTIST2 **ARTISTDESIGN** EEDA 2007 2012 2013 201

SEVENTH FRAMEWORK PROGRAMME

## Building Excellence

#### in the area, in Europe

• 337 publications

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- 27% joint
- Several best papers
  - Cluster got all 3 best papers at ESWeek 2009
- 8 tools
- 3 spin-offs
- 9 workshops
- 19 tutorials
- 10 special sessions
- 64 invited talks





## Main Scientific Highlights and Insights Gained

- MPSoC timing analysis and optimization
  - Better understanding of the timing of multi-core systems with shared resources, including temperature, reliability and effects of 3D integration
- Mixed criticality systems
- Self-powered systems
  - Harvesting energy from the environment



## **MPSoC System and Analysis Model**

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- real-time analysis via modular performance analysis (MPA)\*
  - streams and resources represented by *arrival/service curves*
  - output: worst-case bounds on system timing properties latency, buffers, temperature

\*modular performance analysis (MPA) http://www.mpa.ethz.ch

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## Thermal Analysis Model in System-Level Design Space Exploration

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- experimental set-up: MJPEG decoder executed on MPARM platform & HotSpot simulator (50 candidate mappings analyzed)
- **objectives:** worst-case peak temperature and overall worstcase latency (both evaluated with MPA)

SEVENTH FR/

## Power, Thermal and Reliability Aware Resource Managment for Multicores Systems (UNIBO, Intel Lab)

• Thermal effects become a scalability wall for manycores due to hot spots

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 Solution: Dynamic operating point control with feedback from HW/SW sensors

• Optimal control: maximize performance & minimize energy at safe temperature

 Based on a fully distributed, scalable Model Predictive Control approach

 Includes estimation and autocalibration of internal thermal models



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# Fault tolerance optimization with harden processors (LiU, DTU)



Increase in reliability / Decrease in process failure probabilities



 $N_1$ 

 $P_1$ 

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Increased execution time of processes Increased hardware cost



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## **Application Example**



#### Viacheslav Izosimov from LiU awarded Best PhD thesis in embedded systems at DATE 2012

80

60

40

20

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Low

accepted architectures

%

**MAX** – nargening-only optimization **MIN** – software-level-only optimization

**OPT** – combined architecture

#### **Accepted architecture:**

- Cost constraint
- Time constraints
- Reliability goal

#### Hardening performance degradation (HPD) 5%

Performance difference between the least hardened and the most hardened versions

#### Maximum cost 20

Medium High % accepted architectures in relation to different technologies (fault rates)

## Task Mapping and Bandwidth Reservation for Mixed Hard/Soft Fault-Tolerant Embedded Systems



- Given: A mixed hard/soft fault-tolerant application and a distributed platform
- Determine: Mapping and Utilization
- Such that:

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- Deadlines for all hard real-time tasks are satisfied (Even in case of faults)
- Probability of meeting of deadline for soft tasks is maximized



## HW/SW Energy Harvesting Techniqes (UNIBO, ETHZ, DTU)

#### Effective, long term, power supplies are limited and/or expensive

#### Goal

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Investigate energy harvesting and management technologies that can support the operation of a smart sensor node **indefinitely** 



Conventional energy management:
How do we save energy ?

Energy harvesting management:
When do we use energy ?

It's a cross-layer issue!



## **Joint Activities**

- Timing analysis: MPSoC scheduling [resources, thermal]
  - SSCGTA-cluster and MV-cluster

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- Workshops Software Synthesis and MAP2MPSOC
- Predictability: MPSoC and NoC
- Reliability: Fault-tolerance [timing, power/reliability]
- Adaptivity: Run-time management, self-healing MPSoC

## **Tools and Platforms**

- **SymTA/S**: Development and verification of embedded multiprocessor real-time systems (TUBS,ETHZ,SymtaVision,AbsInt)
- Analysis and optimization framework for fault tolerant distributed embedded systems (LiU,DTU)
- **MPHP**: An integration of MPA parallelization assistant and MH static memory allocation for MPSoC (IMEC,KTH,Dortmund,TU/e,DUTH)
- **MoVES**: Modelling and verification of embedded systems (DTU,AAU)
- **MPA**: Modular Performance Analysis (ETHZ, TUBS)
- **DOL**: Distributed operation layer (ETHZ,UNIBO)

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- **McNoC**: Multicore network on chip (KTH,NTUA,NUDT)
- . ForSyDe: Formal system design (KTH,DTU) integrated with SystemC

Many of the tools are used and further developed together with industry in ARTEMIS and FP7 projects



#### Lasting Impacts Future interaction beyond the end of the NoE

Research

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- Heavy influence on ARTEMIS program and projects
- NanoTera [Swiss project 2008-2020]
- ARAMIS [German many-core project 2011-2014]
- Guardian Angels [EU FET Flagship]
- Education
  - iCES [Masters Program in Embedded Systems, KTH + industry]
  - Models of Multicore Programming [Masters Program in at the Sino-Danish University in Beijing, China]
  - Exchange program [KTH and Fudan University in Shanghai, China]
- Industry
  - 3 start-up companies [Symtavision, Wispes, BiomiCore]
  - Large number of "Artist" PhDs now going into industry
  - Contribution to standards [AVB, RTJava]
  - Education and awareness of Systems Engineering for Embedded Systems [4 year program in Denmark]
- Community
  - ADSIG (EDAA)



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## **Start-up Companies**



## Final Overall Assessment

- The efforts to establish an integrated modeling and design methodology that can take into account predictability and efficiency constraints have successfully been continued from ARTIST2
- Focus on both multi- and many-core platforms as well as platforms for distributed networked systems
- Special emphasis on resource-awareness. Obtained a better understanding of the timing of multi-core systems with shared resources through the development of timing analysis methods that have been applied to industrial use cases
- Challenge to include and handle consequences of emerging technologies
  - 3D chip integration, variability, microfluidic biochips and self-powered wireless sensors
  - Risk assessment [insight gained from industry collaborations]



## **Final Overall Assessment**

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#### Embedded Systems is a *technology* NOT just a service!



